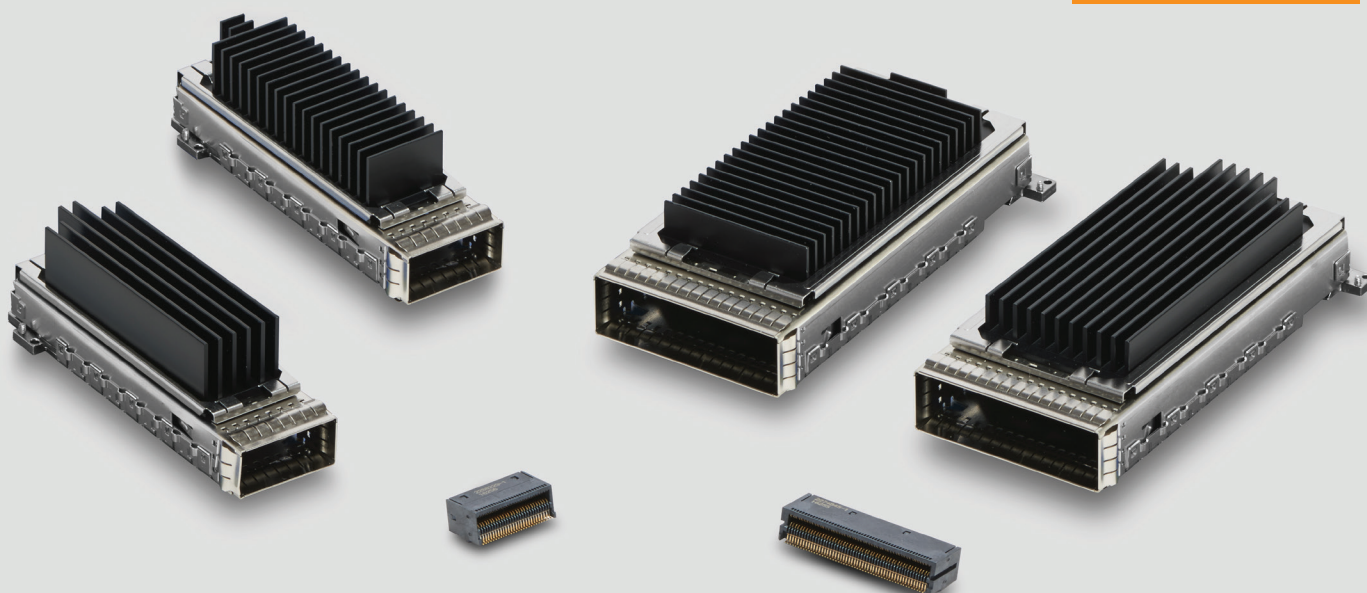




CFP2 & CFP4 PLUGGABLE I/O CONNECTORS & CAGES

CFP2 and CFP4 interconnects transfer data 2.8 times faster than current CFP products, achieving 28 Gbps per lane for >100 Gbps Ethernet (and other protocols) in a high density, 0.6mm contact pitch. TE Connectivity's (TE) CFP2 and CFP4 connectors provide excellent signal integrity and feature a ruggedized cage construction for a more robust solution than the competition, helping ensure reliable connections. With one of the largest CFP2 and CFP4 portfolios, TE offers many flexible design options to meet your needs.

Applications

- Carrier Networks and Datacenters
- Large datacenter campus connectivity
- Metro area networks
- Mid- to long-reach, high capacity, multi-100 Gbps links

CFP2 & CFP4 PLUGGABLE I/O CONNECTORS & CAGES

Part Number Information

CFP2

Description	TE Part Number
Receptacle Connector	2274845-1
1x1 Receptacle Cover	2304452-1
1x1 Cage Assembly	2274843-2
1x2 Receptacle Cover	2304454-1
1x2 Cage Assembly	2287076-2
Heatsink (side-to-side airflow)	2288219-3
Heatsink (front-to-back airflow)	2288218-3
Heatsink Clip	2288220-2
EMI/Dust Plug	2288221-1
1x1 Hardware Kit (w/side-to-side airflow heatsink)	2274842-1
1x1 Hardware Kit (w/front-to-back airflow heatsink)	2274842-2
1x2 Hardware Kit (w/side-to-side airflow heatsinks)	2287075-1
1x2 Hardware Kit (w/front-to-back airflow heatsinks)	2287075-2

CFP4

Description	TE Part Number
Receptacle Connector	2288229-1
1x1 Receptacle Cover	2304455-1
1x1 Cage Assembly	2288227-2
1x4 Receptacle Cover	2304456-1
1x4 Cage Assembly	2289496-2
Heatsink (side-to-side airflow)	2289501-3
Heatsink (front-to-back airflow)	2288231-3
Heatsink Clip	2289502-2
EMI/Dust Plug	2288221-3
1x1 Hardware Kit (w/side-to-side airflow heatsink)	2288226-1
1x1 Hardware Kit (w/front-to-back airflow heatsink)	2288226-2
1x4 Hardware Kit (w/side-to-side airflow heatsink)	2289497-1
1x4 Hardware Kit (w/front-to-back airflow heatsink)	2289497-2

Hardware kits include: cage assembly, receptacle cover, heatsink(s), heatsink clip(s) and screws.

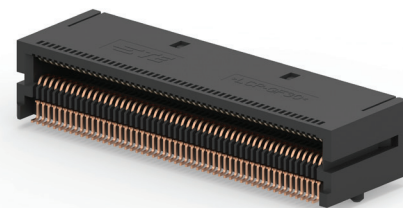
te.com

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1-1773867-7 07/17 DND



CFP2 receptacle connector

Key Features

- Up to 28 Gbps per lane; 100 Gbps per port
- 32 Gbps ACO compliant
- Up to 4x data rate per 19" line card vs CFP
- Up to 60% lower power consumption vs CFP
- 0.6mm pitch SMT receptacle connectors
- Pin counts:
 - CFP2: 104 pins
 - CFP4: 56 pins
- Ganged configurations available:
 - 1x1 and 1x2 cages for CFP2
 - 1x1 and 1x4 cages for CFP4
- Supports single-sided and belly-to-belly mounting
- Designed to the CFP2 & CFP4 MSA standards (www.cfp-msa.org)
- Meets CEI-28G-VSR requirements defined by OIF for 28 Gbps
- Accommodates 32 Gbps ACO requirements
- Optional riding heatsink ensures proper thermal dissipation

Contact your TE representative for more information

TE Technical Support Center

USA:	1.800.522.6752
Canada:	1.905.475.6222
Mexico:	52.0.55.1106.0800
Latin/S. America:	54.0.11.4733.2200
Germany:	49.0.6251.133.1999
UK:	44.0.800.267666
France:	33.0.1.3420.8686
Netherlands:	31.0.73.6246.999
China:	86.0.400.820.6015

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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